

FDS6575

P-Channel 2.5V Specified PowerTrench^O MOSFET

General Description

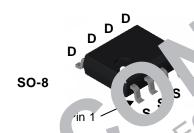
This PChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V – 8V).

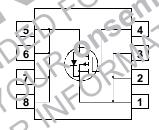
Applications

- · Power management
- Load switch
- · Battery protection

Features

- -10 A, -20 V. $R_{DS(ON)} = 13 \text{ m}\Omega$ @ $V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 17 \text{ m}\Omega$ @ -2.5 V
- · Low gate charge
- High performance treather and per
- High Irre. and po ir handling capability





Absol te Maxin. Ratings Ty-25 Curl so otherwise noteu

Sym 7	Parameter	N	Ratings	Units
V _L	L.uin-Source Vollage		-20	V
V _{GS}	Gate-Source Voltage	•	±8	V
Ъ	Diain Current - Continuous	(Note 1a)	-10	А
11/	– Pulsed		-50	
P _D	Power Lissipation to Single Operation	(Note 1a)	2.5	W
Or		(Note 1b)	1.5	
		(Note 1c)	1.2	
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	-55 to +175	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R ₀ JC	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6575	FDS6575	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		I.	1	I	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$, Referenced to 25°C		-13		mV/°C
l _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
IGSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	- 0.	-1.5	V
$\Delta V_{GS(th)} \over \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \mu\text{A}$, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -10 \text{ A}$ $V_{GS} = -2.5 \text{ V}, I_D = -9 \text{ A}$ $V_{GS} = -4.5 \text{ V}, I_D = -10.7 \text{ T}_J = -5^{\circ}\text{C}$		8.5 11	13 17 20	n.Ω
I _{D(on)}	On-State Drain Current	V _{GS} = -4.5 V, '' ₂₅ = - V	-50	7		Α
G FS	Forward Transconductance	V _{DS} = -5 V' =		57		S
Dynamic	Characteristics		60	o'	4.	
Ciss	Input Capacitance	$V_{DS} = V$, $v_{SS} = 0 V$,		[:5]		ρF
Coss	Output Capacitance	= 1.0 Mi.	0/	884		pF
C _{rss}	Reverse Transfer Capacitan	NV		451	//	pF
Switchin	g Characteristic (No.	WE, OO,	<u> </u>		•	
t _{d(on)}	Turn-On Delay Tin	$V_{DD} = -10V$, $I_D = 1 A$,		16	29	ns
t _r	Turn-Or .sc ./me	$V_{3S} = -4.5 \text{ V}.$ $R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn-C Delay Time	D. VO. VK.		196	314	ns
t _f	Ofi \II Tim	17 CO.		78	125	ns
Qg	T- te Criarge	$V_{LS} = -10 \text{ V}$ $I_D = -10 \text{ A},$		53	74	nC
Q _{gs}	Gate-s urce Charge	$V_{GS} = -4.5 \text{ V}$		6		nC
G,	Guy-Drain Charge			12		nC
Dra –Se	ource Diode Characteristics	and Maximum Ratings				
1'3	iviax mum Conuncus Drain Scurce				-2.1	Α
V _{SD}	Drain-Scurce Diude Folward Voltage	V _{GS} = 0 V, I _S = -2.1 A (Note 2)		-0.6	-1.2	V

l'otes :

1. R_{BJA} is the sum of the junction-co-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJC} is guaranteel by design while R_{BCA} is determined by the user's board design.



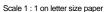
a) 50 °C/W when mounted on a 1in² pad of 2 oz copper



b) 105 °C/W when mounted on a .04 ir² pad of 2 oz copper



c) 125 °C/W when mounted on a minimum pad.



2. Pulse Test: Pulse Width < $300\mu s,$ Duty Cycle < 2.0%

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Typical Characteristics

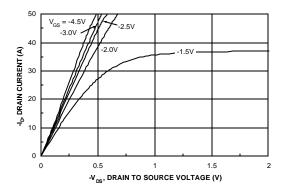


Figure 1. On-Region Characteristics.

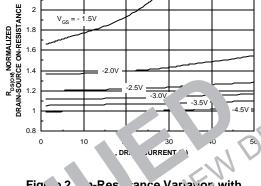


Fig. 2. 1-Res ance Variation with D. in C rer and Gate Voltage.

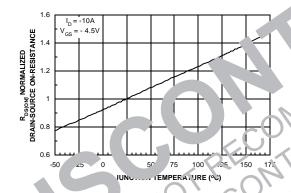


Fig. re c. on-Resistance Variation with Termperature.

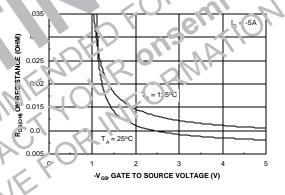


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

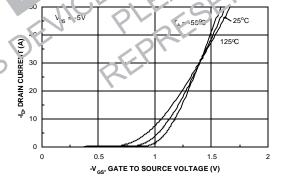


Figure 5. Transfer Characteristics.

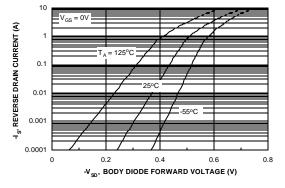
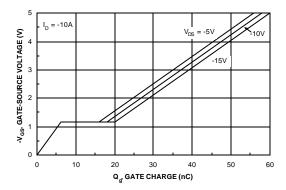


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

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Typical Characteristics



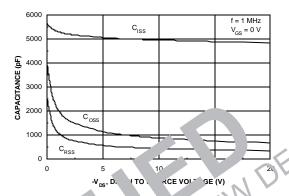
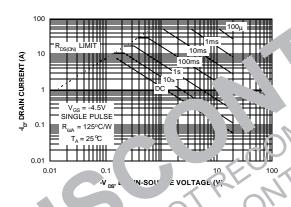
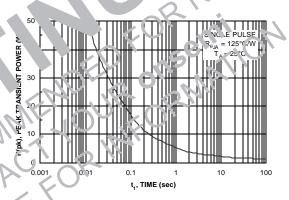


Figure 7. Gate Charge Characteristics.







Fi vre 9 May num Safe Operating Area.

Figure 10. Single Pulse Maximum Power Dissipation.

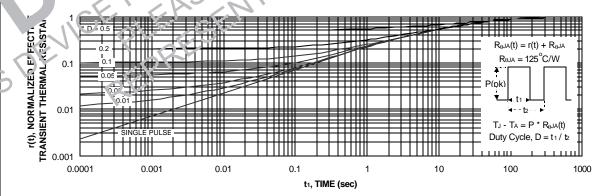


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient thermal response will change depending on the circuit board design.

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